#### SCOPE:

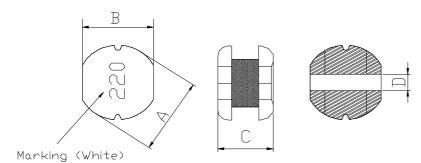
This specification applies to the Pb Free high current type SMD inductors for MSCD-0311-SERIES

#### PRODUCT INDENTIFICATION

#### MSCD - 0311 - 220 K

- ① ② ③④
- ① Product Code
- **② Dimensions Code**
- **3 Inductance Code**
- **4** Tolerance Code

# (1) SHAPES AND DIMENSIONS



A: 3.5 ± 0.3 mm B: 3.0 ± 0.3 mm C: 1.1 ± 0.3 mm D: 1.2 Typ. mm

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

#### **TEST INSTRUMENTS**

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

# (3) CHARACTERISTICS

(3)-1 Ambient temperature ...... +60°C Max.

(3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C



## **TABLE 1**

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current	Morking	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC(A)	Marking	
MSCD-0311-1R0□	1.0	M	100kHz/0.25V	85m	1.50	1R0	
MSCD-0311-1R2□	1.2	M	100kHz/0.25V	95m	1.45	1R2	
MSCD-0311-2R2□	2.2	M	100kHz/0.25V	0.20	1.00	2R2	
MSCD-0311-3R3□	3.3	M	100kHz/0.25V	0.22	0.87	3R3	
MSCD-0311-4R7□	4.7	M,N	100kHz/0.25V	0.31	0.65	4R7	
MSCD-0311-5R6□	5.6	M	100kHz/0.25V	0.32	0.60	5R6	
MSCD-0311-6R8□	6.8	M	100kHz/0.25V	0.33	0.55	6R8	
MSCD-0311-8R2□	8.2	M	100kHz/0.25V	0.48	0.52	8R2	
MSCD-0311-100□	10	K,M	100kHz/0.25V	0.52	0.45	100	
MSCD-0311-120□	12	K,M	100kHz/0.25V	0.65	0.43	120	
MSCD-0311-150□	15	K,M	100kHz/0.25V	0.85	0.42	150	
MSCD-0311-180□	18	K,M	100kHz/0.25V	1.00	0.41	180	
MSCD-0311-220□	22	K,M	100kHz/0.25V	1.20	0.40	220	
MSCD-0311-330□	33	K,M	100kHz/0.25V	1.98	0.26	330	
MSCD-0311-470□	47	K,M	100kHz/0.25V	2.60	0.16	470	
MSCD-0311-560□	56	K,M	100kHz/0.25V	3.20	0.15	560	
MSCD-0311-680□	68	K,M	100kHz/0.25V	3.70	0.12	680	
MSCD-0311-101□	100	K	100kHz/0.25V	6.60	0.10	101	

**<sup>※</sup>** ☐ specify the inductance tolerance,K(±10%),M(±20%),N(±30%)



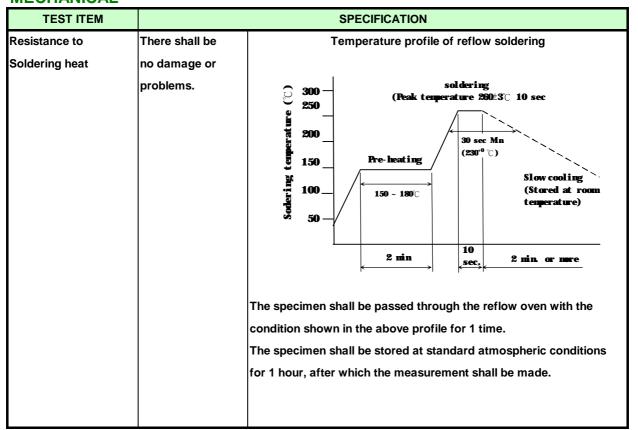
<sup>%</sup> IDC : Based on inductance change ( $\triangle$ L/Lo : drop 10% Max.) @ambient temperature 25° $\mathbb C$  and Based on temperature rise ( $\triangle$ T : 40° $\mathbb C$  TYP.)

# (4) RELIABILITY TEST METHOD MECHANICAL

## **TEST ITEM SPECIFICATION TEST DETAILS** Substrate bending The sample shall be soldered onto the printed circuit board ∆L/Lo≦±5% in figure 1 and a load applied unitil the figure in the arrow There shall be direction is made approximately 3mm.(keep time 30 seconds) no mechanical PCB dimension shall the page 7/9 damage or elec-F(Pressurization) trical damege. HH 45±2 **PRESSURE ROD** figure-1 Vibration The sample shall be soldered onto the printed circuit board ∆L/Lo≦±5% and when a vibration having an amplitude of 1.52mm There shall be and a frequency of from 10 to 55Hz/1 minute repeated should no mechanical be applied to the 3 directions (X,Y,Z) for 2 hours each. damage. (A total of 6 hours) New solder Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated Solderability More than 90% over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of 130~150℃ and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5℃. More than 90% of the electrode sections shall be couered with new solder smoothly when the sample is taken out of the solder bath.



#### **MECHANICAL**



#### **ELECTRICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS		
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top		
resistance	no other	surface and the terminal.		
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$ .		
	problems.			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top		
withstand	no other	surface and the terminal of this sample		
voltage	damage or			
	problems.			
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in		
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value		
		calculated based on the value applicable in a normal		
		temperature and narmal humidity shall be △L/L20℃ ≦±10%.		



# **ENVIROMENT CHARACTERISTICS**

TEST ITEM		SPECIFICATION								
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with								
storage		a tempe	a temperature of 85±2℃ and a normal humidity.							
	There shall be	hall be Upon completion of the measurement shall be made after the								
	no mechanical	sample has been left in a normal temperature and normal								
	damage.	humidity for 1 hour.								
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with								
storage		a temperature of -25±3℃.								
	There shall be	Upon co	Upon completion of the test, the measurement shall be made							
	no mechanical	after the	after the sample has been left in a normal temperature and							
	damage.	normal I	normal humidity for 1 hour.							
Change of	∆L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown								
temperature		in the ta	in the table 2 below and then it shall be subjected to standard							
	There shall be	atmospheric conditions for 1 hour, after which measurement								
	no other dama-	shall be made.								
	ge of problems									
		table 2								
				Temperature	Duration					
			1	<b>−25±3</b> °C	30 min.					
			(Themostat No.1							
			2	Standard	No.1→No.2					
				atmospheric						
			3	<b>85±2</b> ℃	30 min.					
				(Themostat No.2)						
			4	Standard	No.2→No.1					
				atmospheric						
Moisture storage	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in a temperature of							
			40±2 $^{\circ}$ and a humidity(RH) of 90 $^{\circ}$ 95%.							
	There shall be	_	Upon completion of the test, the measurement shall be made							
	no mechanical	after the sample has been left in a normal temperature and								
	damage.		normal humidity more than 1 hour.							
Test conditions :										

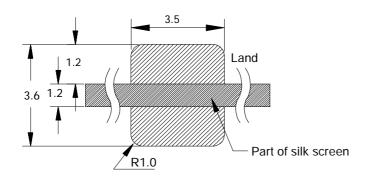


# (5) LAND DIMENSION (Ref.)

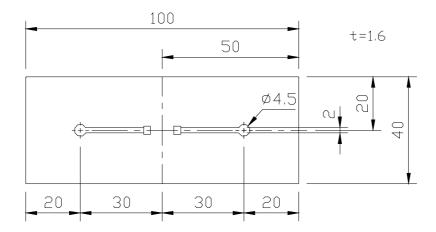
PCB: GLASS EPOXY t=1.6mm

### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm

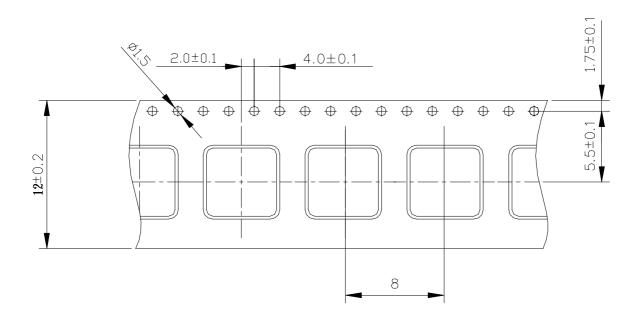


### (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



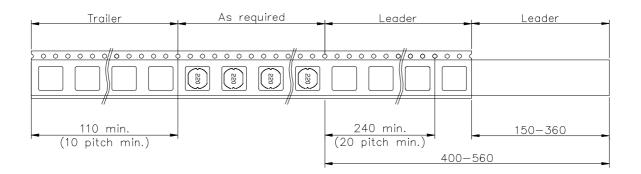
# (6) PACKAGING

## (6)-1 CARRIER TAPE DIMENSIONS (mm)

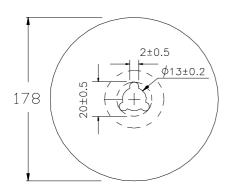


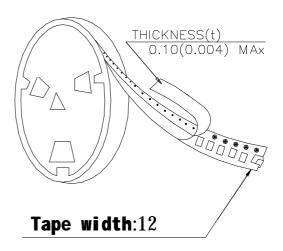
# (6)-2 TAPING DIMENSIONS (mm)





# (6)-3 REEL DIMENSIONS (mm)





## (6)-4 QUANTITY

1000 pcs/Reel

The products are packaged so that no damage will be sustained.

